

Stenciling Procedure for Component Parts/Assemblies ES 7.3-14 Appendix 2

Each print, after a release date of March 1, 2007, will reflect a code that will inform the machine shop where and how to stencil/identify a component part/assembly. Listed below are the codes and definition of each code to be added to each print. Refer to QI-7.5.3-04 Instructions for Maintaining Traceability for stamping requirements.

<u>Code</u>	<u>Definition</u>	<u>Where Used</u>
S1	1/8 Engraving / ⓐ Alternate Steel Stamp	Most commonly used on Components
S2	1/4 Engraving / ⓐ Alternate Low Stress Dot Stamp	Large Assemblies
E1	Etch	Thin walled components
T1	Tag or Bag	Components too small to etch
P1	Paint Pen	Parts that can't be stamped, etched, tagged or bagged

Note:

ⓐ For wall thickness less than 1/8", Stamping cannot be used.

For convenience, markings can be applied lengthwise along part or assembly,
But must not cross any seal surfaces. Contact Engineering if there are any questions.

